

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.



FDC30N20DZ Dual N-Channel PowerTrench[®] MOSFET

30 V, 4.6 A, 31 mΩ

Features

- Max $r_{DS(on)}$ = 31 m Ω at V_{GS} = 10 V, I_D = 4.6 A
- Max $r_{DS(on)}$ = 38 m Ω at V_{GS} = 4.5 V, I_D = 4.2 A
- High Performance Trench[®] Technology for Extremely Low r_{DS(on)}
- Fast Switching Speed
- 100% UIL Tested
- Typical CDM ESD protection level > 2.0 kV (Note 5)
- RoHS Compliant

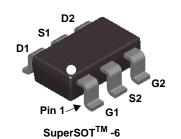


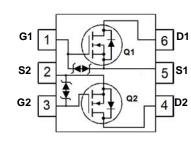
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process. This process has been optimized for $r_{\mbox{DS(on)}},$ switching performance and ruggedness.

Applications

- Load Switch
- Synchronous Rectifier





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Parameter		Ratings	Units	
V _{DS}	Drain to Source Voltage		30	V	
V _{GS}	Gate to Source Voltage		±20	V	
I _D	Drain Current -Continuous	(Note 1a)	4.6	A	
	-Pulsed	(Note 4)	30	Α	
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	3	mJ	
P _D	Power Dissipation	(Note 1a)	0.96		
	Power Dissipation	(Note 1b)	0.69		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	130	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1b)	180	0/10

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.30N20	FDC30N20DZ	SSOT-6	7 "	8 mm	3000 units

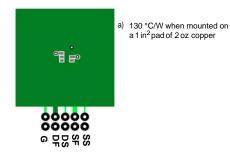
March 2016

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, V_{GS} = 0 \ V$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		22		mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±10	μA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1	1.7	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{I}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-4		mV/°C
0	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 4.6 A		23	31	mΩ
r _{DS(on)}		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 4.2 \text{ A}$		27	38	
		V _{GS} = 10 V, I _D = 4.6 A, T _J = 125 °C		31	42	
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 4.6 A$		23		S
C _{iss} C _{oss}	Input Capacitance Output Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1MHz		356 110	535 165	pF pF
C _{rss}	Reverse Transfer Capacitance			18	30	pF
R _g	Gate Resistance		0.1	3.5	7.0	Ω
Switching	Characteristics					1
t _{d(on)}	Turn-On Delay Time			6	12	ns
t _r		$V_{\text{DD}} = 15 \text{ V}, \text{ I}_{\text{D}} = 4.6 \text{ A}, \\ V_{\text{GS}} = 10 \text{ V}, \text{ R}_{\text{GEN}} = 6 \Omega$		2	10	ns
t _{d(off)}	Turn-Off Delay Time			13	21	ns
t _f	Fall Time	V _{GS} = 0 V to 10 V		2	10 7.9	ns nC
Q _{g(TOT)}	Total Gate Charge			5.6 2.7	3.8	nC
Q _{g(TOT)}	Gate to Source Charge	$V_{GS} = 0 V \text{ to } 4.5 V$ $V_{DD} = 15 V,$ $I_{D} = 4.6 A$		0.9	3.0	nC
Q _{gs} Q _{gd}	Gate to Drain "Miller" Charge			0.9		nC
×	-			0.0	1	
	Irce Diode Characteristics			0.05	4.0	V
V _{SD}	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 4.6 A$ (Note 2)		0.85 10	1.2	V
t _{rr}	Reverse Recovery Time	— I _F = 4.6 A, di/dt = 100 A/μs		10	20	ns

FDC30N20DZ Dual N-Channel PowerTrench[®] MOSFET

Q_{rr} NOTES:

1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



Reverse Recovery Charge

2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. E_{AS} of 3 mJ starting T_J = 25 °C; N-ch: L = 0.1 mH, I_{AS} = 8 A, V_{DD} = 27 V, V_{GS} = 10 V. 4. Pulse Id measured at td <= 250 μ s, refer to SOA graph for more details.

5. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

©2016 Fairchild Semiconductor Corporation FDC30N20DZ Rev.1.0

www.fairchildsemi.com

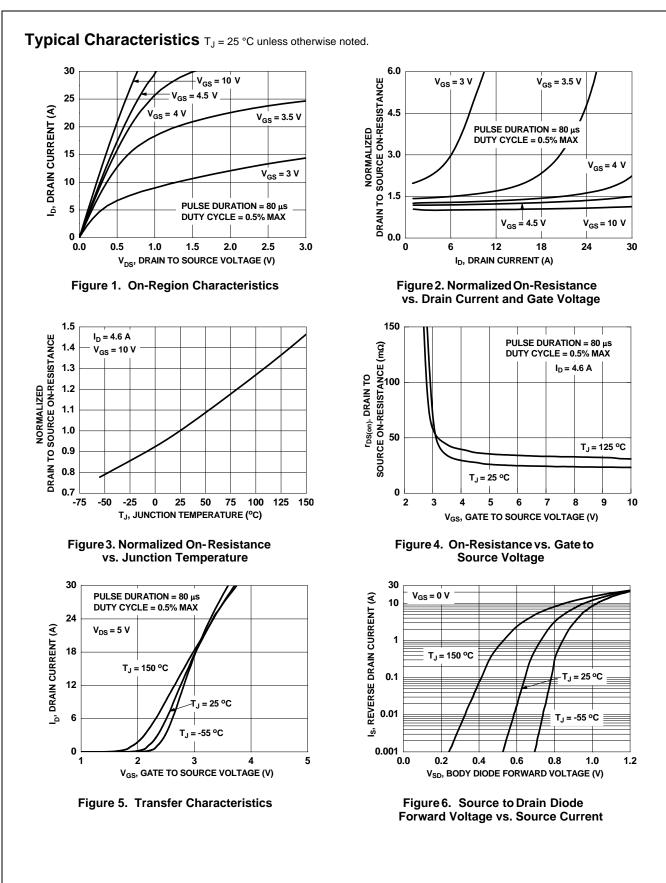
2

b) 180 °C/W when mounted on a

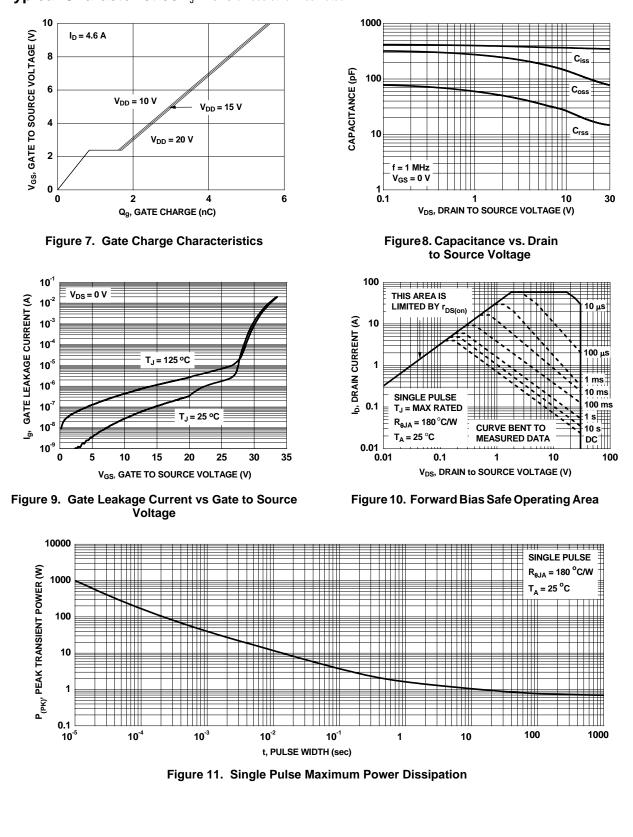
000 GPRSSS minimum pad of 2 oz copper

10

nC



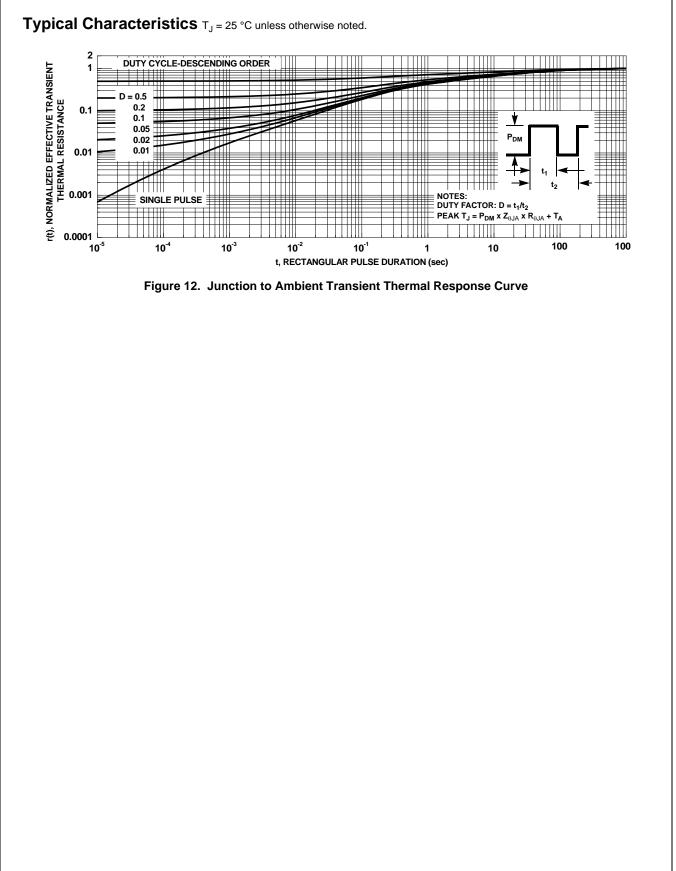
©2016 Fairchild Semiconductor Corporation FDC30N20DZ Rev.1.0 www.fairchildsemi.com

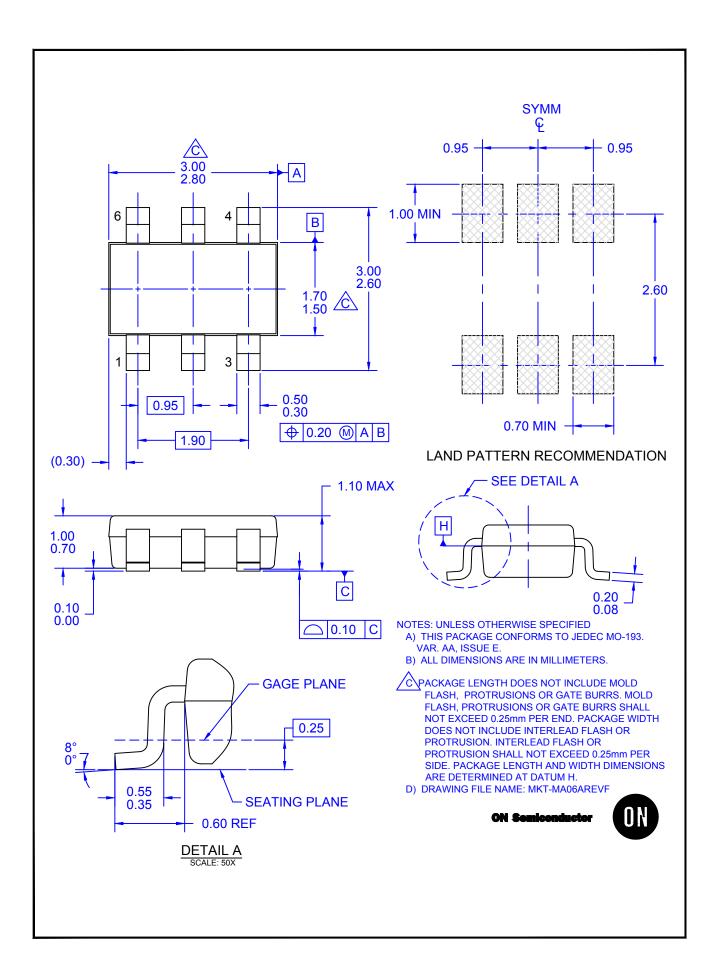


Typical Characteristics T_J = 25 °C unless otherwise noted.

©2016 Fairchild Semiconductor Corporation FDC30N20DZ Rev.1.0 www.fairchildsemi.com

FDC30N20DZ Dual N-Channel PowerTrench[®] MOSFET





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC